

General Description

The WSF50P04 is the highest performance trench P-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF50P04 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

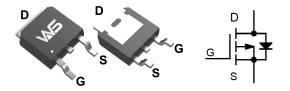
Product Summery

BVDSS	RDSON	ID
-40V	12mΩ	-40A

Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

TO-252 Pin Configuration



Absolute Maximum Ratings (Tc=25℃unless otherwise noted)

Symbol	Parameter	Limit	Unit	
V _{DS}	Drain-Source Voltage	-40	V	
Vgs	Gate-Source Voltage	±20	V	
I D	Drain Current-Continuous	-40	А	
l⊳ (100°C)	Drain Current-Continuous(Tc=100℃)	-28	А	
Ідм	Pulsed Drain Current	-160	Α	
P□	Maximum Power Dissipation Tc=25°C	80	W	
Eas	Single pulse avalanche energy (Note 5)	544	mJ	
d∨/dt	Drain Source voltage slope, V _{DS} ≤-32 V,	50	V/ns	
d∨/dt	Reverse diode dv/dt, V _{DS} ≤-32 V, I _{SD} <i<sub>D</i<sub>	15	V/ns	
Тл,Тѕтс	Operating Junction and Storage Temperature Range	-55 To 175 °C		
Reuc	Thermal Resistance,Junction-to-Case(Note 2)	1.88	°C/W	
Reja	Thermal Resistance,Junction-to-Ambient(Note 2)	50	°C/W	



Electrical Characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Тур	Max	Unit
Off Character	istics					
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-40			V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =-40V,V _{GS} =0V			-1	μΑ
Igss	Gate-Body Leakage Current	Vgs=±20V,Vps=0V			±100	nA
On Character	istics (Note 3)					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =-250µA	-1.0	-1.5	-3.0	V
RDS(ON)	Drain-Source On-State Resistance	Vgs=-10V, Ip=-12A		12	14	mΩ
		Vgs=-4.5V, ID=-12A		18.5	24	mΩ
g FS	Forward Transconductance	V _{DS} =-5V,I _D =-12A		34		S
Dynamic Cha	racteristics (Note4)					
Clss	Input Capacitance			2960		PF
Coss	Output Capacitance	V _{DS} =-20V,V _{GS} =0V, F=1.0MHz		370		PF
Crss	Reverse Transfer Capacitance			310		PF
Switching Ch	aracteristics (Note 4)					
t _{d(on)}	Turn-on Delay Time			10		nS
tr	Turn-on Rise Time	V _{DD} =-20V,I _D =-12A V _{GS} =-		18		nS
td(off)	Turn-Off Delay Time	10V,R _G =3Ω		38		nS
tf	Turn-Off Fall Time			24		nS
Qg	Total Gate Charge			42.2	72	nC
Qgs	Gate-Source Charge	V _{DS} =-20,I _D =-12A, V _{GS} =- 10V		6.9		nC
Qgd	Gate-Drain Charge			9.7		nC
Drain-Source	Diode Characteristics					
VsD	Diode Forward Voltage (Note 3)	V _{GS} =0V,I _S =-12A			-1.2	V
ls	Diode Forward Current (Note 2)				-40	Α
trr	Reverse Recovery Time	T _J = 25°C, I _F =- 12A		40		nS
Qrr	Reverse Recovery Charge	$di/dt = -100A/\mu s_{(Note3)}$		42		nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. Eas condition: Tj=25 $^{\circ}\text{C}$,Vdd=-20V,Vg=-10V,L=1mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics

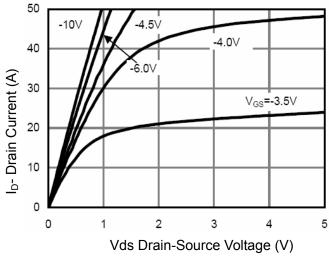


Figure 1 Output Characteristics

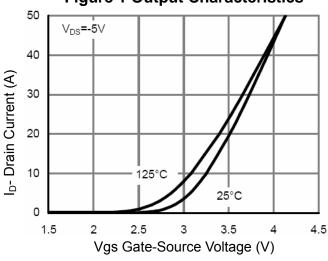


Figure 2 Transfer Characteristics

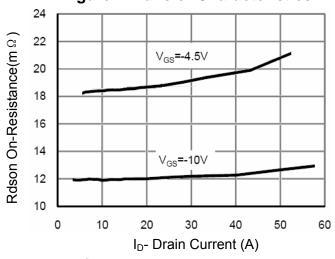


Figure 3 Rdson- Drain Current

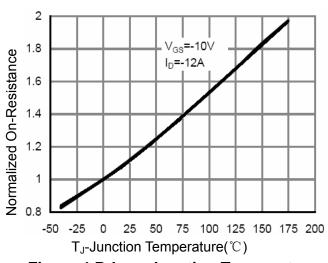
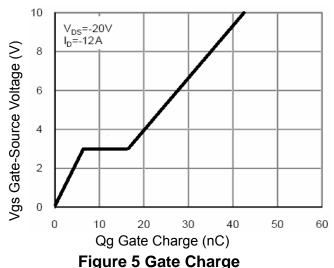
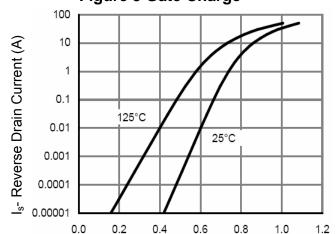


Figure 4 Rdson-Junction Temperature





Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward



P-Ch MOSFET

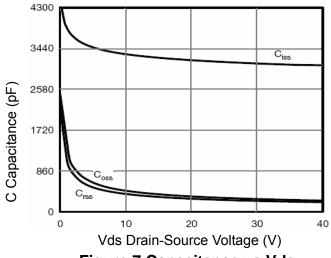


Figure 7 Capacitance vs Vds

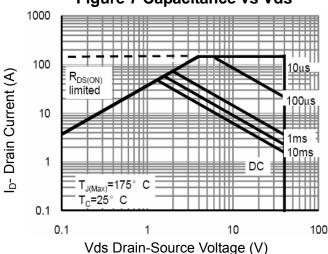


Figure 8 Safe Operation Area

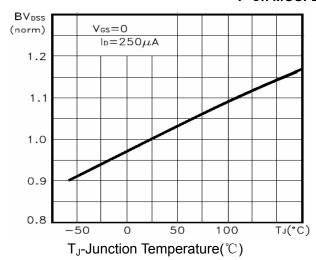


Figure 9 BV_{DSS} vs Junction Temperature

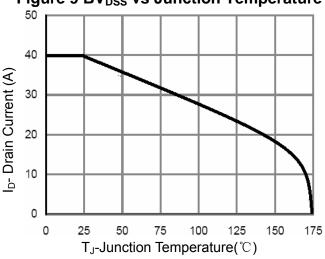


Figure 10 ID Current Derating vs Junction Temperature

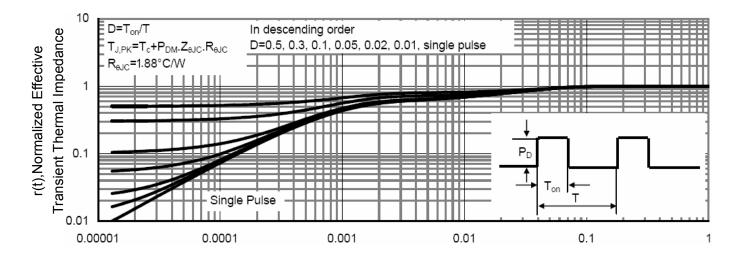


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



Attention

- 1, Any and all Winsok power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your Winsok power representative nearest you before using any Winsok power products described or contained herein in such applications.
- 2, Winsok power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all Winsok power products described or contained herein.
- 3, Specifications of any and all Winsok power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- 4, Winsok power Semiconductor CO., LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- 5,In the event that any or all Winsok power products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- 6, No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of Winsok power Semiconductor CO., LTD.
- 7, Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Winsok power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- 8, Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the Winsok power product that you Intend to use.
- 9, this catalog provides information as of Sep.2014. Specifications and information herein are subject to change without notice.